

XFM-5050-UV 4-chip Surface Mount UVC LED

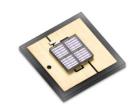


Table of Contents

Ripping Structure

billing structure
Ordering Information3
Optical and Electrical Characteristics
Mechanical Dimensions 7
Soldering Profile8
Packing & Labeling
Precautions for Use 10
History of Changes 11

Features

- Ultra-high power UVC LED: >240 mW output power at 275 nm
- Compact, cost effective 5050 package
- Designed to maximize irradiance in high flow applications
- Wide viewing angle >130°
- Standard SMT Process
- RoHS and REACH compliant

Applications

- Air Purification
- · Water Purification
- Surface Disinfection
- Medical Device Sterilization
- Appliance Sterilization
- Food & Beverage Preparation



XFM-5050-UV Binning Structure

XFM-5050-UV LEDs are tested for radiometric flux and wavelength at a drive current of 2000 mA, 20 ms single pulse at 25° C and placed into one of the following radiometric flux (FF) and wavelength (WWW) bins. The LEDs can also be driven at other drive currents, to achieve the correlated flux values listed in the table.

Radiometric Flux Bins

Flux Bin (FF)	Minimum Flux Maximum Flux (FF) (mW) (mW)		Correlated Minimum Flux (mW) at 25° C		
	2000 mA, 25° C 2000 mA, 25° C	2000 mA, 25° C	1400 mA	2600 mA	3200 mA
GA	225	250	161	296	362
GB	250	275	179	329	402
GC	275	300	196	361	442
GD	300	325	213	393	480
GE	325	350	230	425	520

Note 1: Product lifetime is a function of drive current. Sustained operation at absolute maximum current of 3200 mA will result in a reduction of device lifetime compared to typical forward drive currents (1400 mA-2000 mA). Actual device lifetimes will also depend on junction temperature. Contact Luminus for information on product lifetime.

Note 2: Correlated minimum flux values are for reference only. XFM-5050 are tested and binned only at the test current of 2000 mA.

Wavelength Bins

Wavelength Bin (WWW)	Minimum Wavelength (nm) Maximum Wavelength	
270	270	275
275	275	280

Note: Luminus maintains a \pm 6% tolerance on flux measurements and \pm 1 nm on wavelength measurements.

Forward Voltage Bins

Voltage Bin	Minimum Voltage (V)	Maximum Voltage (V)
V3	5.0	5.5
V4	5.5	6.0
V5	6.0	6.5
V6	6.5	7.0
V7	7.0	7.5
V8	7.5	8.0

 $Note: Individual\ bins\ are\ not\ orderable.\ Please\ refer\ to\ product\ ordering\ information\ on\ page\ 3\ for\ a\ list\ of\ ordering\ part\ numbers.$



Part Number Nomenclature

XFM —	– 5050 –	– <uv> -</uv>	<d130> -</d130>	- <ffwww-##></ffwww-##>
Product Family	Package Type	Color	Package Configuration	Bin kit
XFM: UVC Surface Mount Package	5050: 5.0 mm x 5.0 mm	UV	D: 4-chip version 130: >130° emission angle	Flux (FF) and Wavelength(WWW) bin kit code See ordering informaton

Ordering Part Numbers

The table below lists ordering part numbers available for XFM-5050-UV LEDs. The part number includes a bin kit, a group of flux and wavelength bins described in page 2, that are shippable for a given ordering part number. Individual flux or wavelength bins are not orderable. Flux bin listed is minimum bin shipped - higher bins may be included at Luminus' discretion.

Wayalangth Danga	Mayalanath Pins	Radiometric Flux		Ordering Part Number
Wavelength Range Wavelength Bins		Bin Kit Flux Code	Min. Flux (mW)	Ordering Part Number
270-280	270, 275	GA	225	XFM-5050-UV-D130-GA270-00
270-280	270, 275	GB	250	XFM-5050-UV-D130-GB270-00



Optical and Electrical Characteristics

Parameter	Symbol	Typical	Unit
Test Current	I _f	2000	mA
Minimum Forward Voltage	$V_{\text{f-min}}$	5.0	V
Typical Forward Voltage	$V_{\text{f-typ}}$	6.75	V
Maximum Forward Voltage	V _{f-max}	7.75	V
FWHM	Δλ	12	nm
Viewing Angle	2θ _{1/2}	150	0
Thermal Resistance (junction-solder point)	R _{th}	1.8	°C/W

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	l _{f-max}	3200	mA
Junction Temperature	T _i	95	°C

Note 1: Ratings are based on operation at a constant junction temperature of $T_i = 25$ °C. Test conditions: 2000 mA, 20 ms pulse at 25°C.

Note 2: XFM-5050-UV LEDs are designed for operation up to an absolute maximum forward drive current as specified above. Product lifetime data is specified at typical forward drive currents. Sustained operation at absolute maximum currents will result in a reduction of device lifetime compared to typical forward drive currents. Actual device lifetimes will also depend on junction temperature.

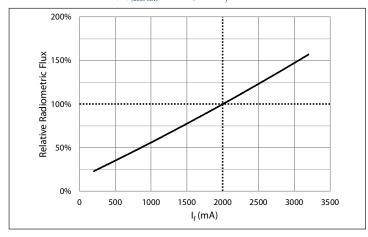
Note 3: Caution must be taken not to stare at the radiation emitted from UV LEDs.



Optical & Electrical Characteristics

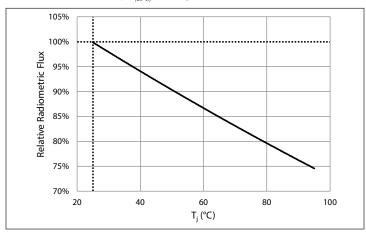
Relative Power vs. Forward Current

 $\varphi/\varphi_{(2000 \text{ mA})}$, 20 ms pulse, $T_i = 25$ °C



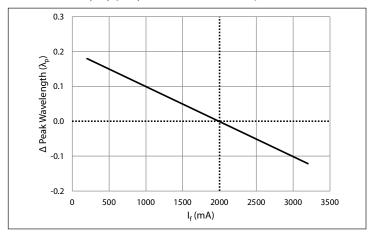
Relative Power vs. Junction Temperature

 $\varphi/\varphi_{(25^{\circ}C)}$, 20 ms pulse, 2000 mA



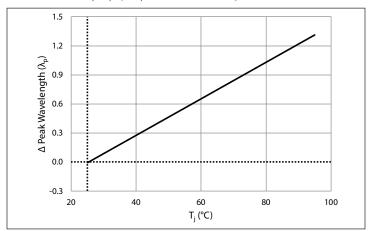
Peak Wavelength Shift vs. Forward Current

 $\lambda_p = \lambda_p(I_f) - \lambda_p$ (2000 mA), 20 ms pulse, $T_i = 25^{\circ}$ C



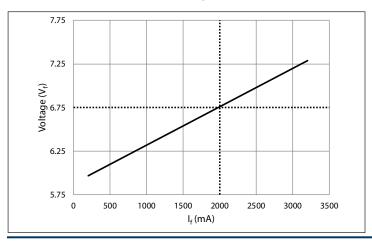
Peak Wavelength Shift vs. Junction Temperature

 $\lambda_p = \lambda_p(T_p) - \lambda_p$ (25°C), 20 ms pulse, $I_p = 2000$ mA



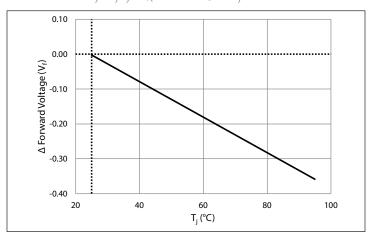
Forward Voltage vs. Forward Current

25°C, 20 ms pulse



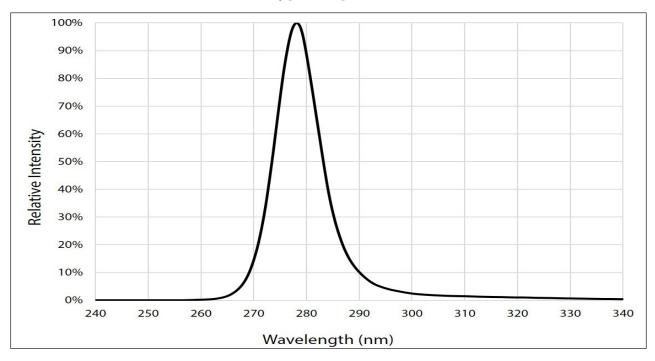
Forward Voltage Shift vs. Junction Temperature

 $\Delta V_f = V_f(T_i) - V f_i 25$ °C), 20 ms pulse, $I_f = 2000$ mA

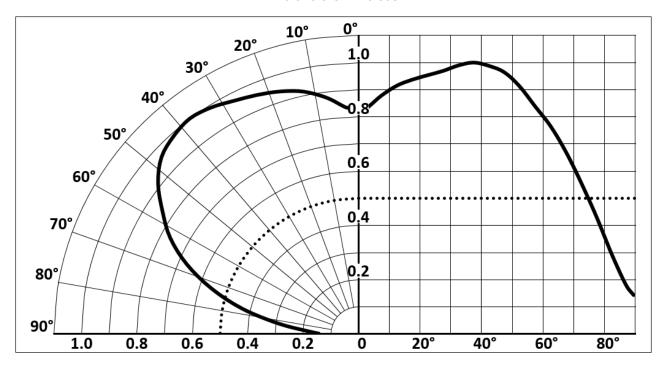




Typical Spectrum

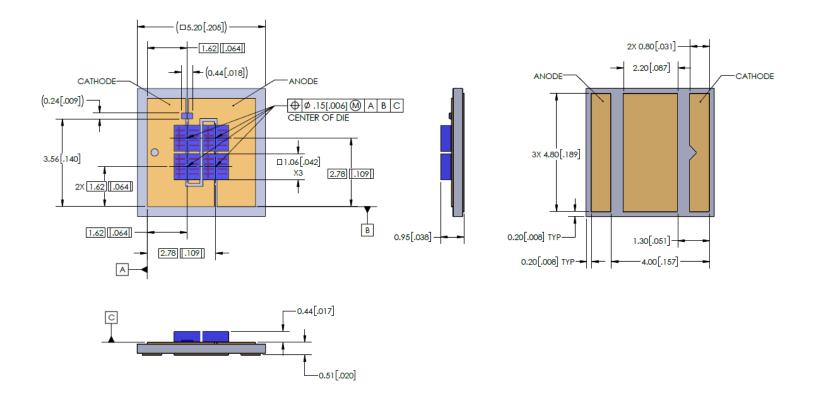


Radiation Pattern

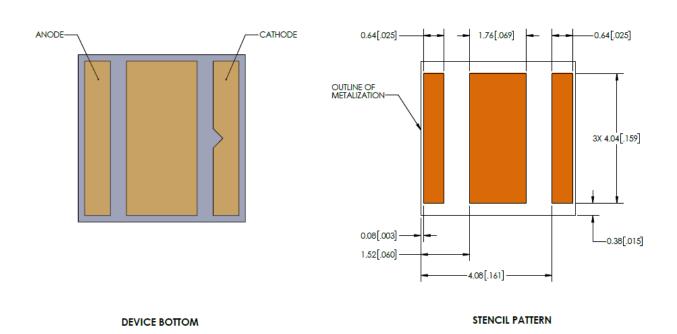




Mechanical Dimensions



Recommended Solder Pad & Stencil Pattern

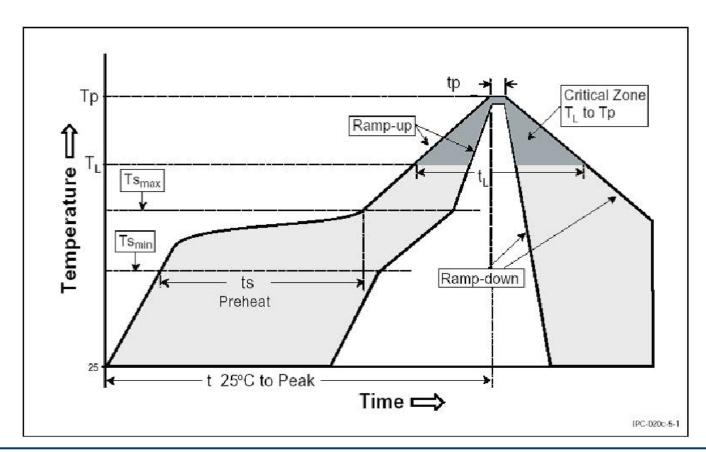




Soldering Profile

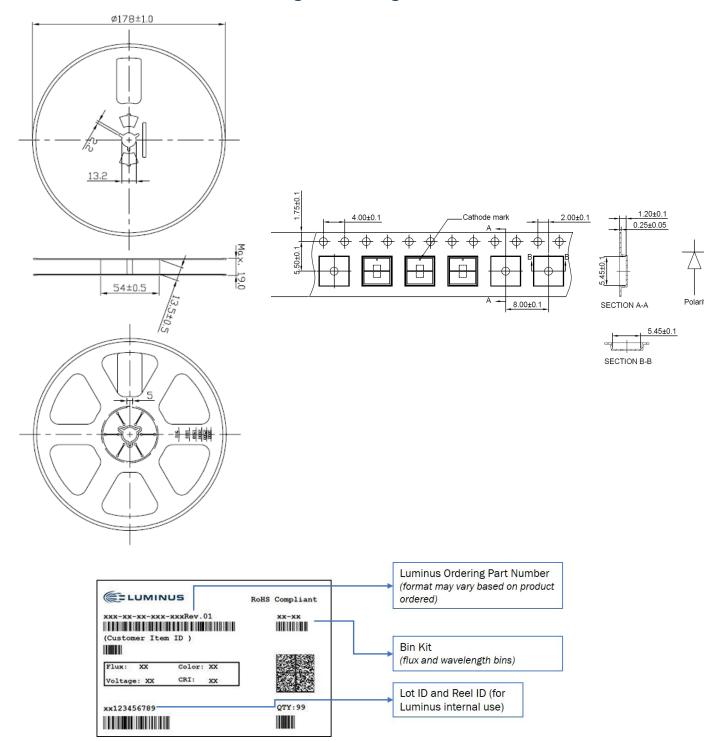
Profile Setting	Pb-Free Profile	
Average Ramp-up Rate $(Ts_{max'}T_p)$	1 °C/sec	
Preheat Temperature Min (Ts _{min})	100-150 ℃	
Preheat Temperature Max (Ts _{max})	180-200 °C	
Preheat Time (ts _{min} to ts _{max})	60-120 sec	
Liquidus Temperature (T _L)	217 °C	
Time Maintained Above $T_L(t_L)$	50-80 sec	
Peak Temperature (T _p)	260 ℃	
Time within 5°C of Actual Peak Temp (t _p)	Max 10 sec	
Ramp-Down Rate	2-3 °C /sec	
25°C to Peak Temperature time	4 mins	

Luminus recommends that users follow the recommended soldering profile provided by the manufacturer of the solder paste used. Note that this general guideline may not apply to all PCB designs and configurations.





Packing & Labeling



Note 1: Maximum of 250 pcs/reel. Lower quantities may be shipped.

Note 2: Minimun of 50pcs/reel.

Note 3: Product complies to MSL 1.



Precautions for storage, handling and use of UV LEDs

1. UV Light

XFM-5050-UV LEDs are short wavelength, deep UV LEDs. During operation, the LED emits high intensity UVC radiation, which is harmful to skin and eyes. UV light is also hazardous to skin and may cause cancer. Avoid exposure to deep UV light when LED is operational.

2. Static Electricity (ESD)

While XFM-5050 LEDs have built-in Zener protection diodes, they are particularly sensitive to ESD (Electrostatic Discharge). Static electricity and surge voltages seriously damage UV LEDs and can result in complete failure of the device. Anti-electrostatic wristband or gloves are recommended when handling the LEDs. All devices, equipment and machinery must be properly grounded and precautions must be taken against surge voltages.

Reference: APN-002815 Electrical Stress Damage to LEDs and How to Prevent It

3. Operating Conditions

In order to ensure the correct functioning of these LEDs, compliance to maximum allowed specifications is important. UV LEDs are particularly sensitive to drive currents that exceed the max operating specifications and may be damaged by such drive currents. The use of current regulated drive circuits is strongly recommended when operating these devices. Customers should also provide adequate thermal management to ensure LEDs do not exceed maximum recommended temperatures. Operating LEDs at temperatures in excess of specification will result in damage and possibly complete failure of the device.



History of Changes

Rev		Description of Change
01	07/28/2021	Rev01 Release

